

PROCESS RESEARCH OF NON-Cz MATERIAL
WESTINGHOUSE ELECTRIC CORP.

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Contract Information

**OBJECTIVE: INVESTIGATE HIGH-RISK, HIGH PAY-OFF IMPROVEMENTS TO WESTINGHOUSE
BASELINE SEQUENCE**

TIME PERIOD: JANUARY 1985 - AUGUST 1985

Contract Tasks

- INVESTIGATE EXCIMER LASER DRIVE OF LIQUID DOPANTS IN DENDRITIC WEB SILICON
- CONDUCT PROCESS SENSITIVITY STUDIES
- DEVELOP COST ANALYSIS (FORMAT A's)
- INVESTIGATE OTHER ADVANCED TECHNIQUES FOR JUNCTION FORMATION

Potential Benefits

- FEWER PROCESSING STEPS
- MORE RAPID PROCESSING
- LESS COSTLY PROCESSING
- MORE UNIFORM CELL PARAMETERS

C-6

PROCESS DEVELOPMENT

Junction Formation Using an Excimer Laser

APPROACH

HEAT SURFACES OF WEB WITH LASER TO DIFFUSE LIQUID DOPANTS

CONDITIONS

WAVELENGTH - 3080 nm

POWER INPUT TO WEB - 0.5 to 2.5 Joules/cm²

EXPERIMENT

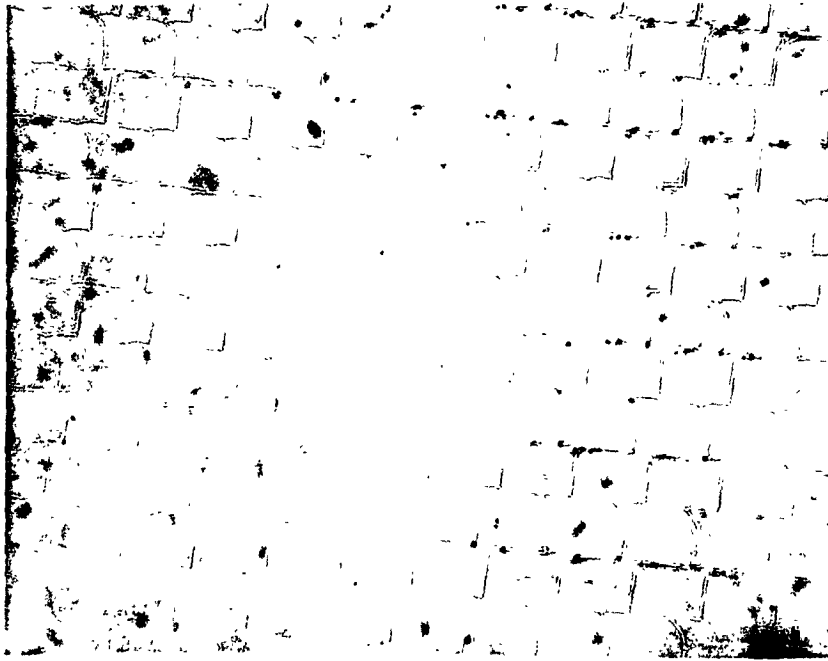
DRIVE B, P, AND AL INTO BOTH N-TYPE AND P-TYPE WEB

LASER PROCESSING CARRIED OUT AT SPECTRA TECHNOLOGY, BELLEVUE, WA,

Results: Excimer Laser

- JUNCTION CHARACTERISTICS
 - N⁺N OR N⁺P (PHOS. DOPED) $C_0 = 10^{19}/\text{cm}^2$ $X_j = 0.2 - 0.25 \mu\text{m}$
 - P⁺N OR P⁺P (B DOPED) ESSENTIALLY NO JUNCTION
 - P⁺P (AL DOPED) ESSENTIALLY NO JUNCTION
- CELL PROPERTIES
 - P TYPE WEB, $\eta_{\text{max}} = 9.6\%$ - DUE TO HIGH RESISTANCE BACK CONTACT (BOTH B & AL BSF)
 - N TYPE WEB, $\eta_{\text{max}} < 1\%$ - POOR B DOPED EMITTER
- ANNEALING UP TO 800°C IMPROVES CELL PROPERTIES
- NO CROSS-CONTAMINATION NOTED
- CRYSTAL PAIRS PROCESSED BASELINE SEQUENCE - $\uparrow = 14\%$ (TOTAL LIQUID SYSTEM)

Sample 18A, p-Base Web, Al BSF 1.5 J/cm²



Sample 14B, p-Base Web, Boron BSF 2.0 J/cm²



PROCESS DEVELOPMENT

Summary of Data

PROCESS	AVG. EFF. (%)
1. WESTINGHOUSE BASELINE - DIFFUSION WITH TOTAL LIQUID SYSTEM (P100 & B150)	14.0
2. P100 FRONT JUNCTION - LASER DRIVE B150 BACK JUNCTION - DIFFUSED	13.2
3. P100 FRONT JUNCTION - DIFFUSED B150 BACK JUNCTION - LASER DRIVE	10.0
4. P100 FRONT JUNCTION - DIFFUSED B150 BACK JUNCTION - LASER DRIVE BACK SURFACE DAMAGED	11.0
5. P100 FRONT JUNCTION - LASER DRIVE B150 BACK JUNCTION - LASER DRIVE	8.6
6. P100 FRONT JUNCTION - LASER DRIVE B150 BACK JUNCTION - LASER DRIVE ANNEAL 700°C - 1 HR IN N ₂	9.6

Dark I-V Data on Selected Cells

Process and Cell ID	Eff. (%)	R _s (Ωcm ²)	R _{sh} (K Ωcm ²)	J ₀₁ (A/cm ²)	J ₀₂ (A/cm ²)	Diffusion Length* (μm)
11-1 Total laser process + 700°C anneal	10.1	.68	22	4.7 x 10 ⁻¹¹	1.8 x 10 ⁻⁶	26
12-2 Total laser process	8.1	.88	6	1.5 x 10 ⁻¹⁰	6.4 x 10 ⁻⁶	19
68-1 Laser drive front junction, diffused BSF	13.2	.68	1.0	1.3 x 10 ⁻¹¹	2.5 x 10 ⁻⁶	36

Front Junction Dopant - P100

Back Junction Dopant - B150

*L_n measured by surface photovoltage technique.

PROCESS DEVELOPMENT

Conclusions: Excimer Laser Processing

- FRONT JUNCTION (PHOSPHORUS DIFFUSED) SATISFACTORY FOR SOLAR CELLS.
- BACK JUNCTION SHALLOW DUE TO SLIGHT PENETRATION OF BORON OR ALUMINUM. RESULTS IN HIGH SERIES RESISTANCE IN CELLS.
- FURTHER TESTS TO BE CARRIED OUT ON LOW RESISTIVITY MATERIAL.

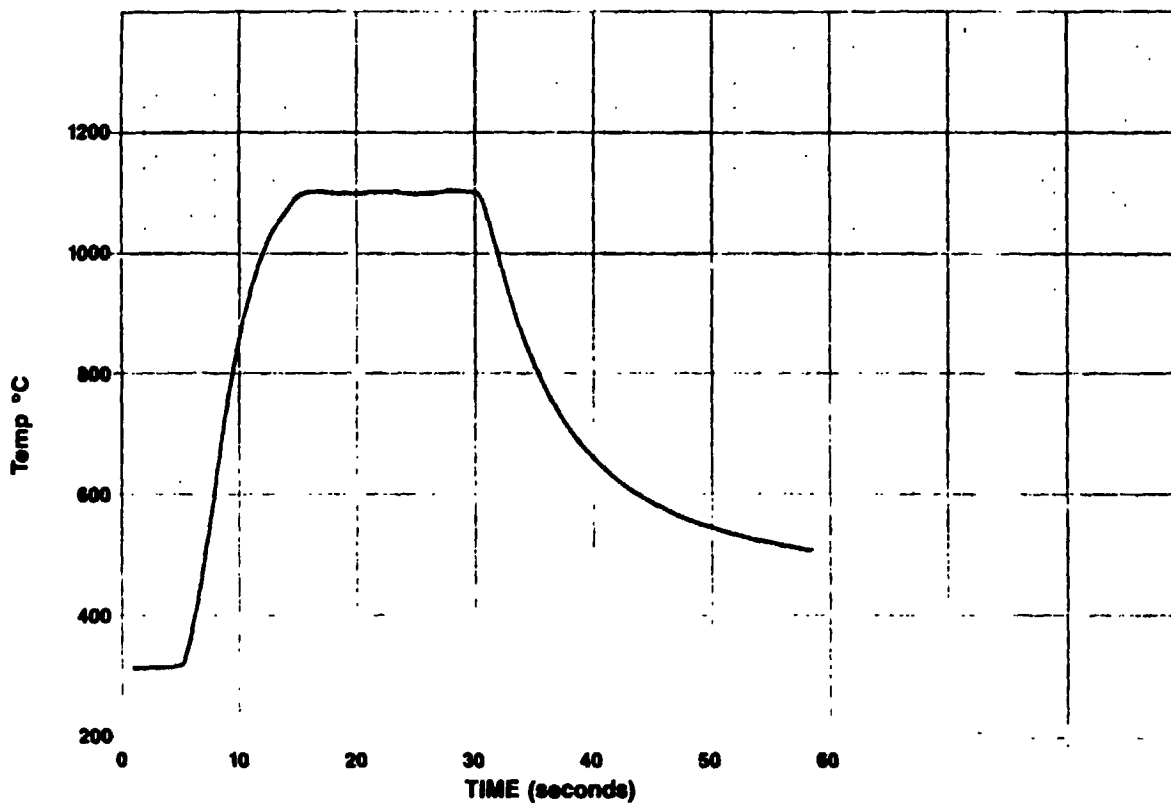
Junction Formation Using a Directed Heat Source

- WEB STRIPS COATED WITH LIQUID DOPANTS (BOTH SIDES) AND HEATED IN A TUNGSTEN-HALOGEN FLASH LAMP
- NOMINAL TIME - 15 SEC.
NOMINAL TEMPERATURE - 1100°C
- JUNCTIONS FORMED SIMULTANEOUSLY ON BOTH SIDES OF WEB STRIP
- N⁺PP⁺ AND P⁺NN⁺ CELLS FABRICATED
- NO CROSS-CONTAMINATION NOTED
- WORK CARRIED OUT COURTESY OF AG ASSOCIATES, PALO ALTO, CA

PROCESS DEVELOPMENT

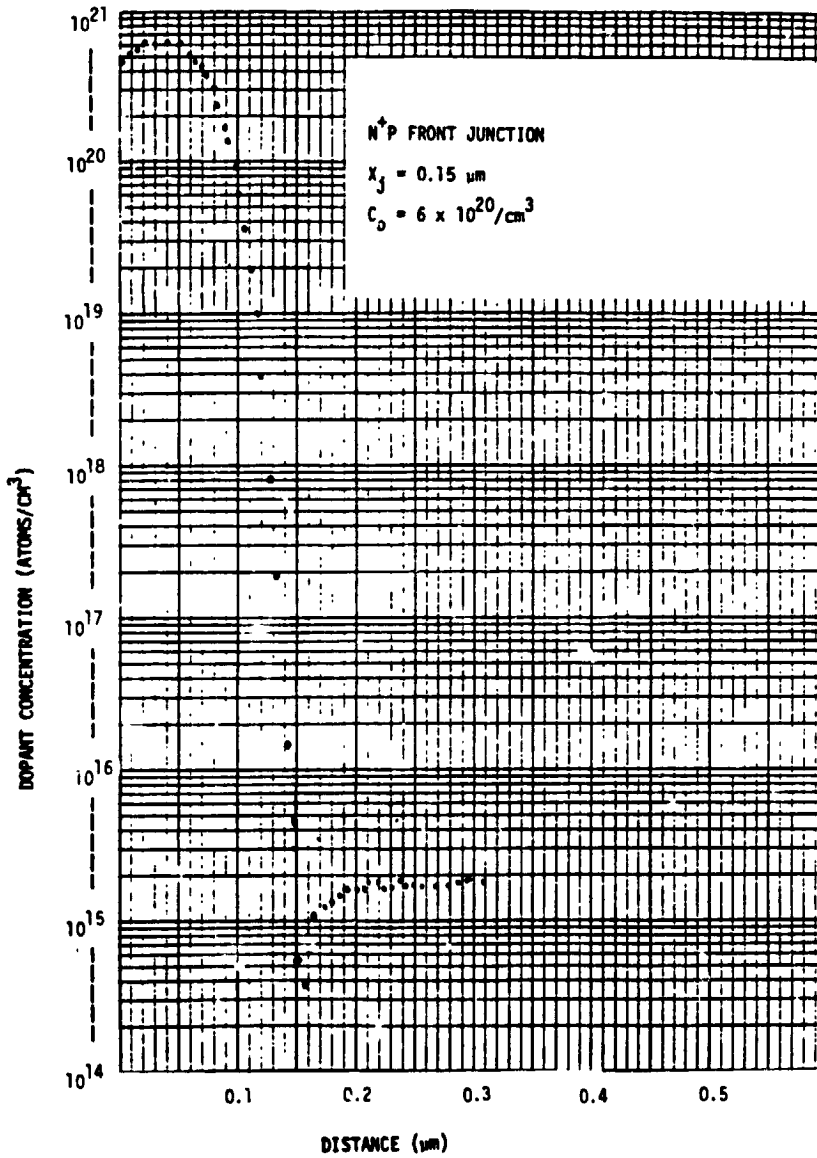
Heat Pulse Temperature-Time Profile

Sample No. WESTINGHOUSE - DENDRITIC WEB



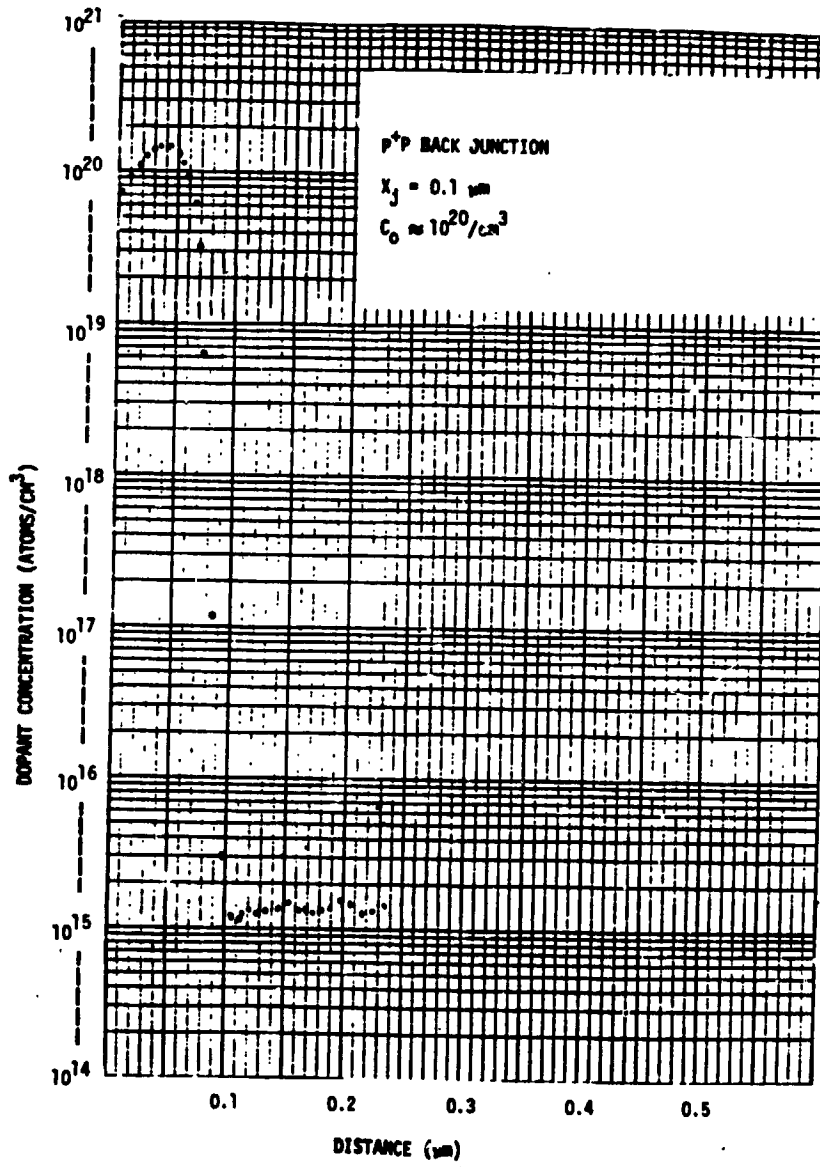
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Heat Pulse Simultaneous Junction Formation



PROCESS DEVELOPMENT

Heat Pulse Simultaneous Junction Formation



PROCESS DEVELOPMENT

Simultaneous Junction Formation Using Heat Pulse:
Representative Data

<u>CELL ID</u>	<u>COND. TYPE</u>	<u>Res (Ωcm)</u>	<u>Voc (V)</u>	<u>Jsc ($\frac{\text{mA}}{\text{cm}^2}$)</u>	<u>FF</u>	<u>EFF.</u>	<u>COMMENTS</u>
8A	P	4	.497	23.8	.76	9.0	AS DIFFUSED
8B	P	4	.541	29.1	.78	12.3	800°C ANNEAL
6A	N	1	.556	24.9	.78	10.8	AS DIFFUSED
6B	N	1	.578	30.5	.75	13.2	800°C ANNEAL
7A	N	1	.561	26.6	.79	11.8	AS DIFFUSED
7B	N	1	.601	32.9	.77	15.0	800°C ANNEAL

Dark I-V Data

<u>SAMPLE</u>	<u>TREATMENT</u>	<u>J₀₂ ($\frac{\text{A}}{\text{cm}^2}$)</u>	<u>Ln (μm)</u>
7A	AS TREATED	6.6×10^{-12}	53
7B	ANNEALED 800°C	1.4×10^{-12}	320

N-TYPE SAMPLES FROM SAME WEB CRYSTAL

PROCESS DEVELOPMENT

Conclusions: Directed Heat-Source Junction Formation

- SIMULTANEOUS DIFFUSION POSSIBLE WITHOUT CROSS-CONTAMINATION
- ANNEALING REQUIRED AFTER JUNCTION FORMATION TO ACHIEVE HIGHEST EFFICIENCY
- A DETAILED STUDY REQUIRED TO OPTIMIZE HEAT PULSE PARAMETERS (TIME/TEMP/COOLING RATE)